Document Number: G2MAH0180-2 Preliminary Datasheet V1.0

## 0.1-8.0GHz,2 stages, 2W, 28V GaN Fully matched PA Module

### **Description**

The G2MAH0180-2 is a 2watt ,2 stage integrated Power Amplifier Module, designed for broad band applications, **frequencies tunable from 100MHz to 8.0GHz with different bias conditions** . The module is 50  $\Omega$  input/output matched and requires minimal external components.



The module implements distributed power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

Vds=28V, ldq1=10 mA, ldq2=10 mA CW with different drain bias inductors

### Output Bias DC feed Inductor L4: BCR-531JLC 530nH

Parameter	0.1GHz	1.0GHz	2.0GHz	3.0GHz	4.0GHz	5.0GHz	6.0GHz	7.0GHz	8.0GHz	Units
Linear Gain	27.0	24. 3	23.5	21.5	20.8	20.7	20.4	19.5	19.3	dB
Gain@Pin=16dBm	20.8	21.3	20.2	19.4	19.2	18.3	17.3	17.3	16.5	dB
Pout@Pin=16dBm	4.1	5. 4	4. 2	3. 5	3. 3	2. 7	2. 1	2. 2	2. 2	W
Eff@Pin=16dBm	41	37	31	25	26	22	17	16	16	%

#### Output Bias DC feed Inductor L4: 1812SMS-R15GLC 150nH

Parameter	0.3GHz	1.0GHz	2.0GHz	3.0GHz	4.0GHz	5.0GHz	6.0GHz	7.0GHz	8.0GHz	Units
Linear Gain	25.8	23.9	23.2	21.3	20.0	21.4	21.1	18.4	19.0	dB
Gain@Pin=16dBm	21.5	21.3	20.3	18.9	18.8	18.6	17.4	17.3	16.4	dB
Pout@Pin=16dBm	5. 7	5. 4	4. 3	3. 1	3.0	2.9	2.2	2. 1	1. 7	W
Eff@Pin=16dBm	41	36	31	23	24	24	17	16	14	%

### Output Bias DC feed Inductor L4: 0807SQ-10N\_L\_ 10nH

Parameter	0.5GHz	1.0GHz	2.0GHz	3.0GHz	4.0GHz	5.0GHz	6.0GHz	7.0GHz	8.0GHz	Units
Linear Gain	23.5	25. 4	25.0	22.2	21.0	21.2	22. 1	19.5	19.5	dB
Gain@Pin=16dBm	19.3	21.5	21.0	19.8	19.5	18.9	18.3	17.8	17.2	dB
Pout@Pin=16dBm	3. 4	5. 6	5. 0	3.8	3. 5	3. 1	2. 7	2.4	2. 1	W
Eff@Pin=16dBm	23	40	37	27	27	24	19	19	15	%

Notice: Above inductors due to SRF difference, have significant cost difference, please make right choice for the band interested

#### **Product Features**

- Operating Frequency Range: 0.1-8.0GHz
- Operating Drain Voltage: +28 V (Up to 32V)
- 50 Ω Input/Output
- Psat: ≥33dBm @28V, ≥34dBm @32V
- Small signal gain:>19dB, Power gain:>17dB @Pin=16dBm
- Minimum efficiency:>15%
- 6x10 mm Surface Mount Package

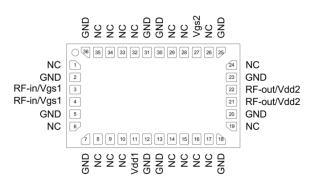
### **Applications**

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios



Document Number: G2MAH0180-2 Preliminary Datasheet V1.0

## **Pin Configuration and Description**



#### Top View

Pin No.	Symbol	Description		
21,22	RFout/Vdd2	Transistor 1, Drain Bias2 & RF Output		
3,4	RFin/Vgs1	Transistor 1, Gate Bias1 & RF Input		
27	Vgs2	Transistor 1, Gate Bias2		
11	Vdd1	Transistor 1, Drain Bias1		
Others	NC	No connection		
2,5,7,12, 13,18,20,23,25, 30, 31,36 Package Base	GND	DC/RF Ground. Must be soldered to EVB ground plane over array of vias for thermal and RF performance. Solder voids under Pkg Base will result in excessive junction temperatures causing permanent damage.		

#### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	150	Vdc
GateSource Voltage	$V_{GS}$	-10 to +2	Vdc
Operating Voltage	$V_{DD}$	+36	Vdc
Input CW Power	RFin	22	dBm
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	T₃	+225	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case, FEA	Rejc	7.5	0000
T <sub>C</sub> = 25°C, DC test	RejC	7.5	°C/W

### **Table 3. Electrical Characteristics**

Parameter	Condition	Min	Тур	Max	Unit	
Frequency Range		100		8000	MHz	
Power Gain		17			dB	
P <sub>OUT</sub>	Pin=16dBm		33		dBm	
Drain Efficiency @ P <sub>SAT</sub> 15 %						
Unless otherwise noted: TA = 25°C. Vpp =28 V. Pulse Width=100 us. Duty cycle=10%						

Load Mismatch of per Section (On Test Fixture, 50 ohm system):  $V_{DD} = 28 \text{ V}$ ,  $I_{DQ1+2} = 10+10 \text{ mA}$ , f = 3.5 GHz

VSWR 10:1 at pulse CW Output Power @Pin=16dBm	No Device Degradation
---	-----------------------



## **Reference Circuit of Test Fixture Assembly Diagram**

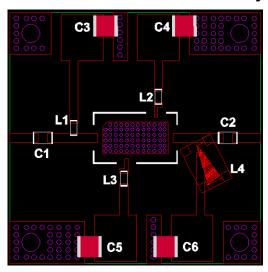
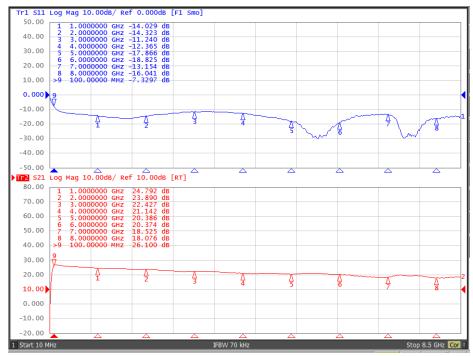


Figure 1. Test Circuit Component Layout

		Part NO.	Vendor
C1, C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
C3,C4,C5,C6	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
L1, L2,L3	470 nH Capacitor(0603)	LQW18CNR47J00D	muRata
L4	530 nH 1.06A Inductor 150nH 1.2A Inductor 10nH 2.7A Inductor	BCR-531JLC 1812SMS-R15GLC 0807SQ-10N_L_	Coilcraft
PCB	RO4350B,20mil,er=3.48		

## **TYPICAL CHARACTERISTICS**

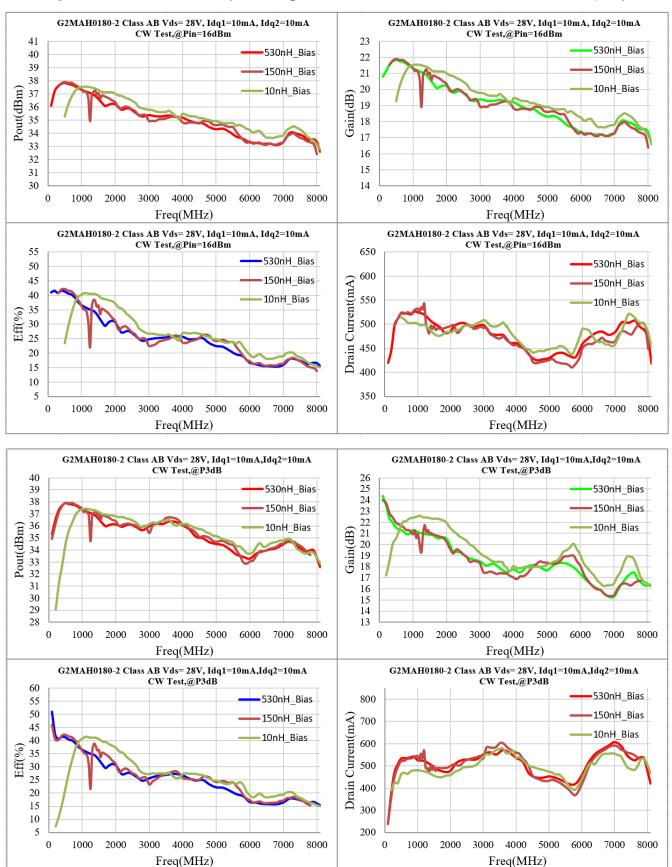
Figure 2. Network analyzer output S11/S21 (VDS= 28V, IDQ1=10 mA IDQ1=40 mA, Pin=0dBm)





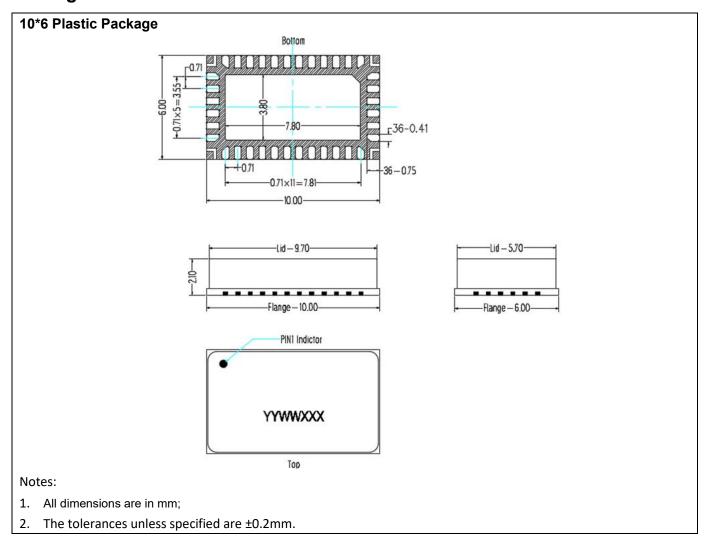
Document Number: G2MAH0180-2 Preliminary Datasheet V1.0

Figure 3. Power Gain and, efficiency and Pout @Pin=16dBm with L4=10nH, P4dB with L4=10&56nH vs. Frequency

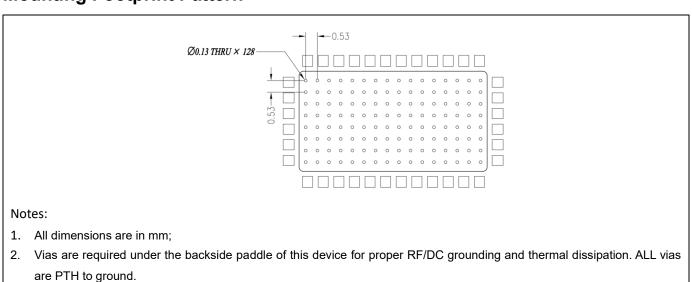


Document Number: G2MAH0180-2 Preliminary Datasheet V1.0

## **Package Dimensions**



## **Mounting Footprint Pattern**





Document Number: G2MAH0180-2 Preliminary Datasheet V1.0

### **Revision history**

Table 6. Document revision history

Date	Revision	Datasheet Status
2023/11/13	Rev 1.0	Preliminary Datasheet Creation

Application data based on ZHH-25-28

#### **Disclaimers**

Specifications are subject to change without notice. Innogration believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogration for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogration . Innogration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innogration in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innogration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogration and authorized distributors Copyright © by Innogration (Suzhou) Co.,Ltd.